



## **Nitta Haas Receives 2010 Supplier Award for Si Wafer Polishing Pad Development from Siltronic**

### ***Dow Electronic Materials' Japanese Joint Venture Recognized for Excellent Product Development in Polishing Pad Technology***

**Newark, DE — February 16, 2011** — Dow Electronic Materials (NYSE:DOW), a leader and innovator in chemical mechanical planarization (CMP) technology for the global semiconductor industry, today announced that its Japanese joint venture, Nitta Haas Inc., has been recognized with a 2010 supplier award from Siltronic AG for its Excellent Product Development in Polishing Pad Technology. Nitta Haas was honored for its years of cooperation with Siltronic, its reliability and timeliness in supplying high quality products which are crucial to the performance of the wafer polishing steps and its commitment to customers.

“Since the start of our Joint Development Project for new polishing pads, our confidence in developing a state-of-the-art polishing process for next generation wafers has been strengthened by Nitta Haas’ improvements and development activities,” said Dr. Christoph von Plotho, president and CEO of Siltronic. “These are achievements that we do not take for granted given the high quality standards and complex technical challenges in our industry. This award acknowledges Nitta Haas’ consistent high level of support of our organization.”

“Recognition for our customer support efforts is the most valuable feedback we can receive from a customer,” said Dr. Masaharu Kinoshita, president of Nitta Haas. “The hard work of the Nitta Haas team led by account manager Pauric O’Donnell with the support of Dow Electronic Materials’ global organization enabled us to achieve this award from Siltronic. We wish to thank Siltronic for this honor and look forward to continuing our successful partnership with them as they continue to move forward with their silicon wafer polishing technology development.”

Dr. Kinoshita and Mr. Koichi Yoshida, general manager of Nitta Haas’ Product Technology Department, accepted the award on January 18, 2011 at a ceremony held at Siltronic’s Headquarters in Munich, Germany.

#### **About Dow**

Dow (NYSE: Dow) combines the power of science and technology with the “Human Element” to passionately innovate what is essential to human progress. The Company connects chemistry and innovation with the principles of sustainability to help address many of the world’s most challenging problems such as the need for clean water, renewable energy generation and conservation, and increasing agricultural productivity. Dow’s diversified industry-leading portfolio of specialty chemical, advanced materials, agrosociences and plastics businesses delivers a broad range of technology-based products and solutions to customers in approximately 160 countries and in high growth sectors such as electronics, water, energy, coatings and agriculture. In 2010, Dow had annual sales of \$53.7 billion and employed approximately 50,000 people worldwide. The Company’s more than 5,000 products are manufactured at 188 sites in 35 countries across the globe. References to "Dow" or the "Company" mean The Dow Chemical Company and its consolidated subsidiaries unless otherwise expressly noted. More information about Dow can be found at



[www.dow.com](http://www.dow.com).

### **About Dow Electronic Materials**

Dow Electronic Materials, a global supplier of materials and technologies to the electronics industry, brings innovative leadership to the semiconductor, interconnect, finishing, photovoltaic, display, LED and optics markets. From advanced technology centers worldwide, teams of talented Dow research scientists and application experts work closely with customers, providing solutions, products and technical service necessary for next-generation electronics. These partnerships energize Dow's power to invent. Its key end-use applications include a broad range of consumer electronics from personal computers, to television monitors, cellular phones, global positioning systems, automobile safety systems, and avionics.

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